

**Application Form**

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| **\* COUNTRY** |  | **Team Leder** |  |
| **\* INVENTOR****&** **Participant**  | **NAME** | **SCHOOL / COMPANY NAME** |
| 1.  |  |
| 2. |  |
| 3. |  |
| 4. |  |
| 5. |  |
| **Write the correct English name and affiliation name / Up to 5 People** |
| **representative****Contact Participant** | **Name** |  |
| **Tel** |  |
| **E-mail** |  |
| **CITY** |  |

**Send to here**: E-mail / Lee37895661@gmail.com

Date : 2024, \_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_

|  |  |
| --- | --- |
| **\*Name of Invention** |  |
| **\*Abstract Of Invention & Photo of Invention** |  |